

Fig. 1

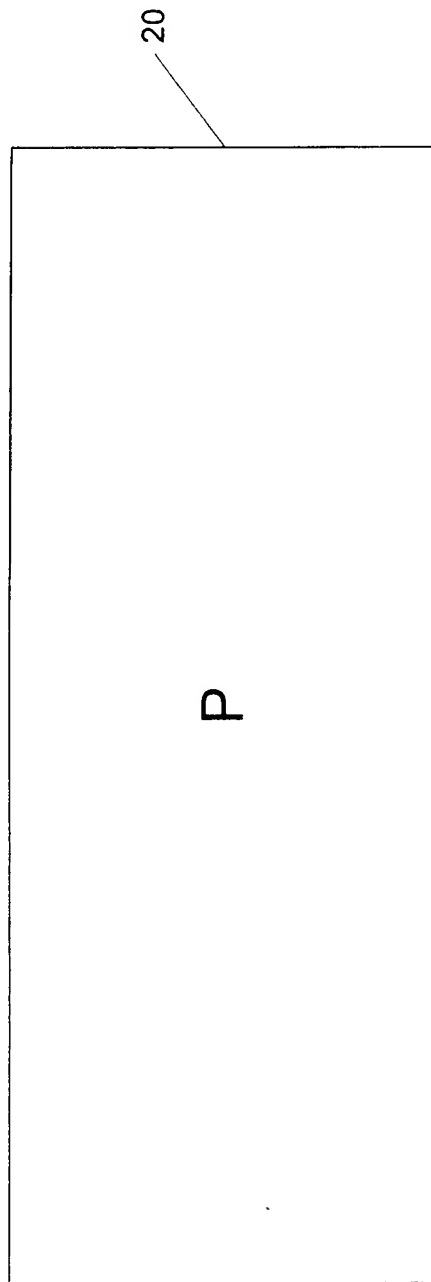


Fig. 2a

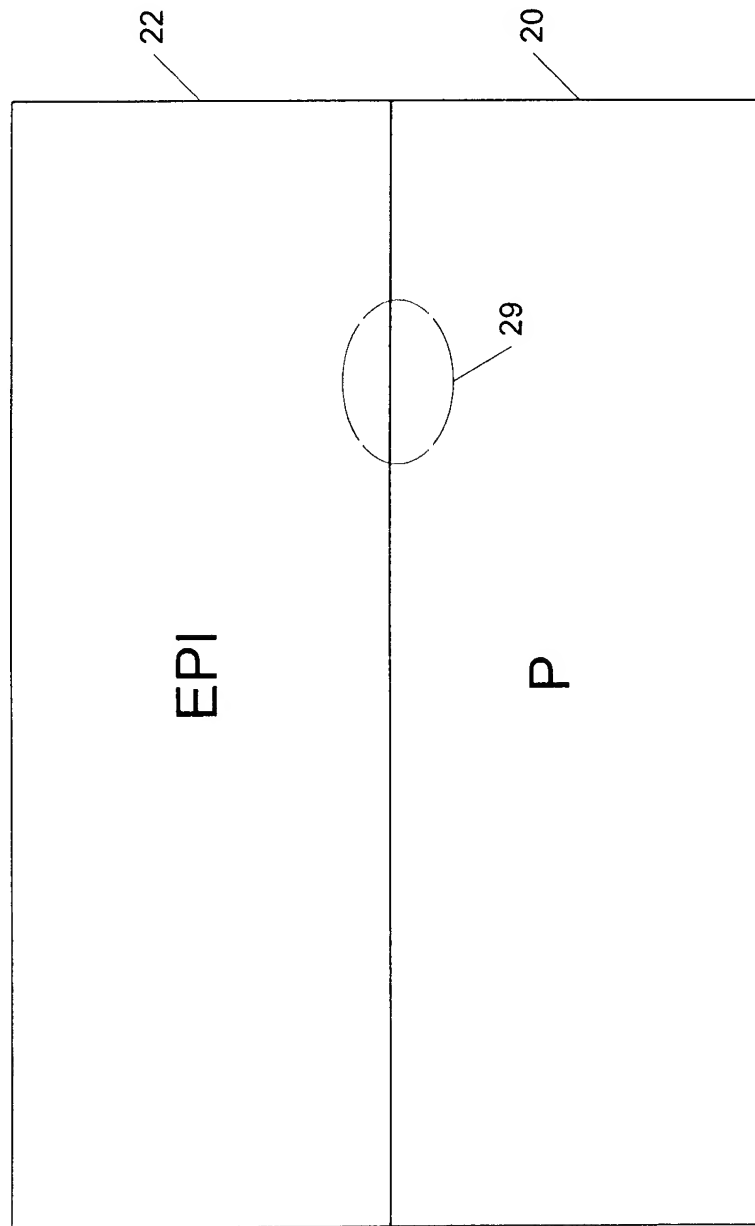


Fig. 2b

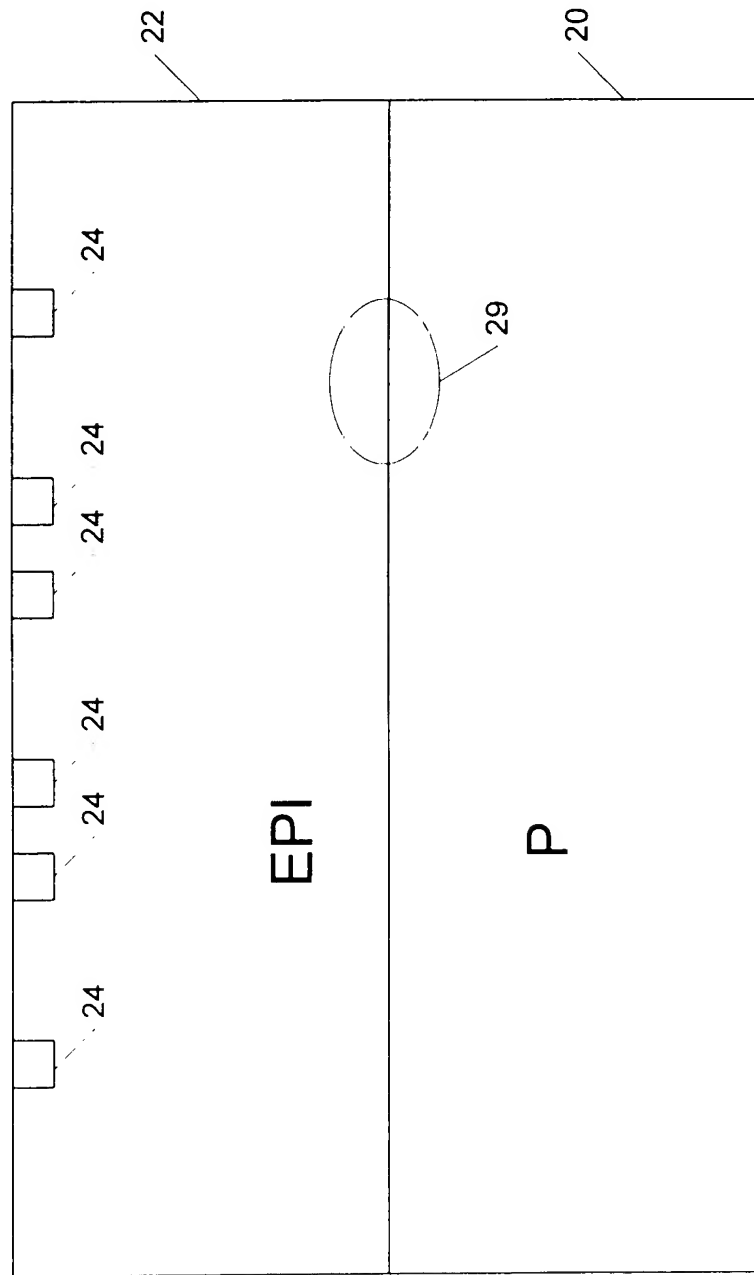


Fig. 2c

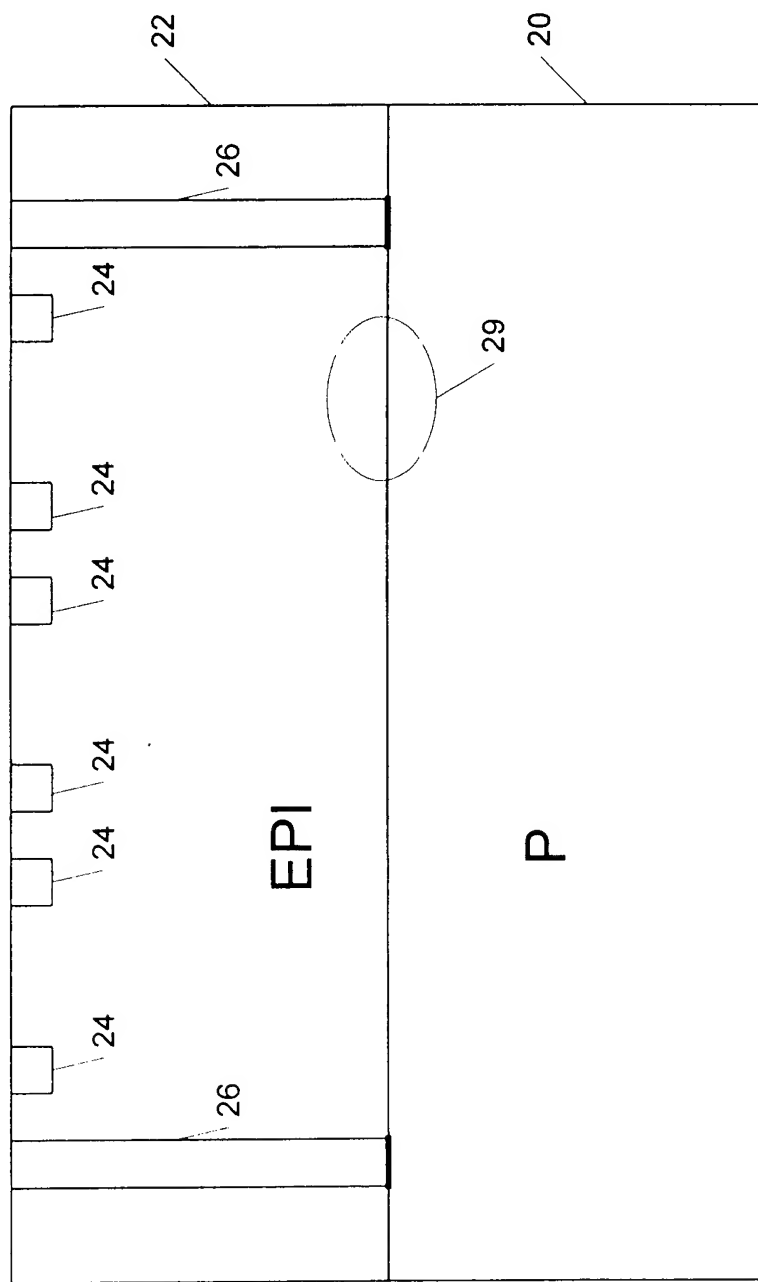


Fig. 2d

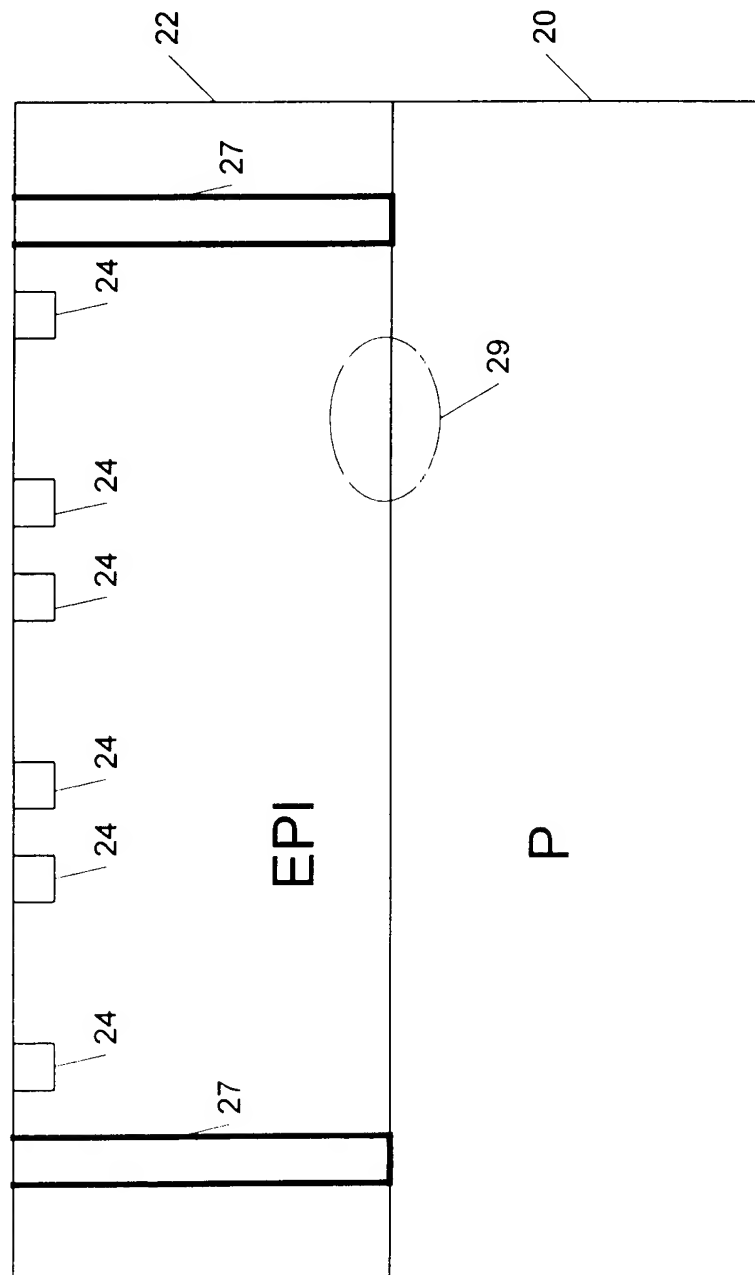


Fig. 2e

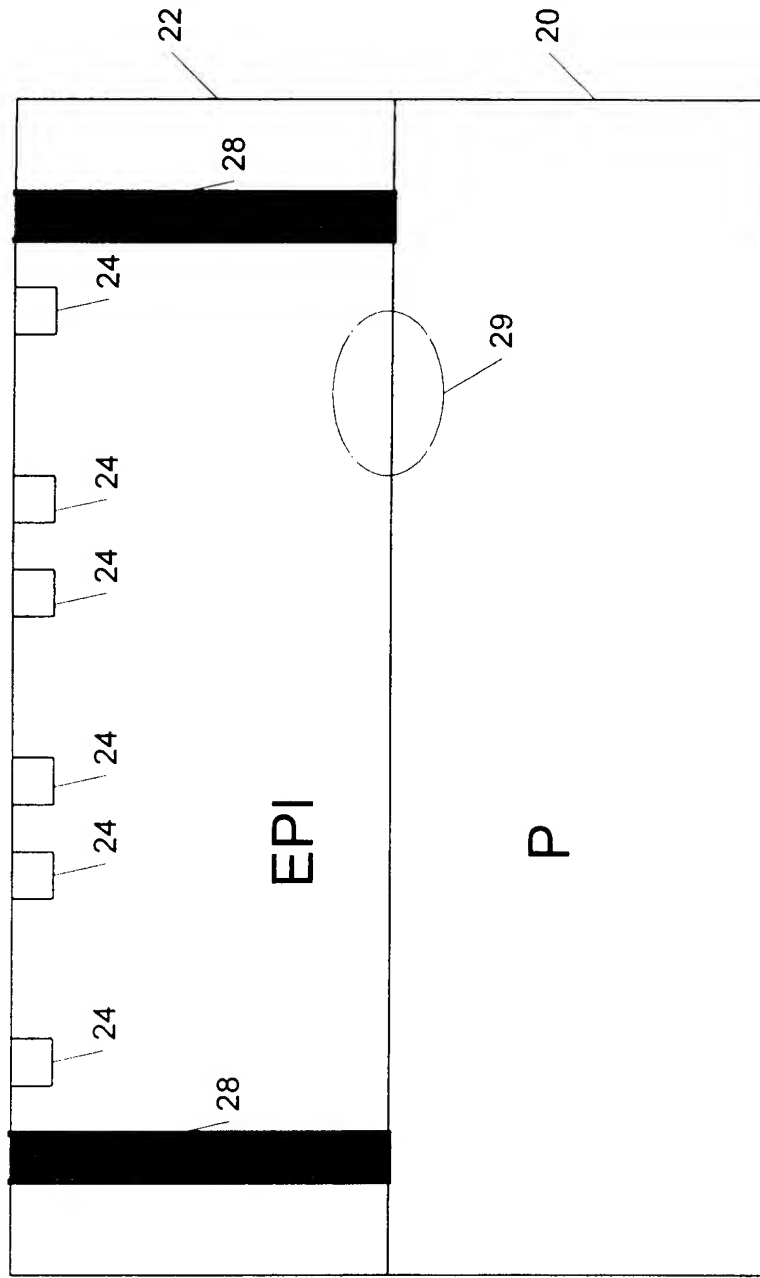


Fig. 2f

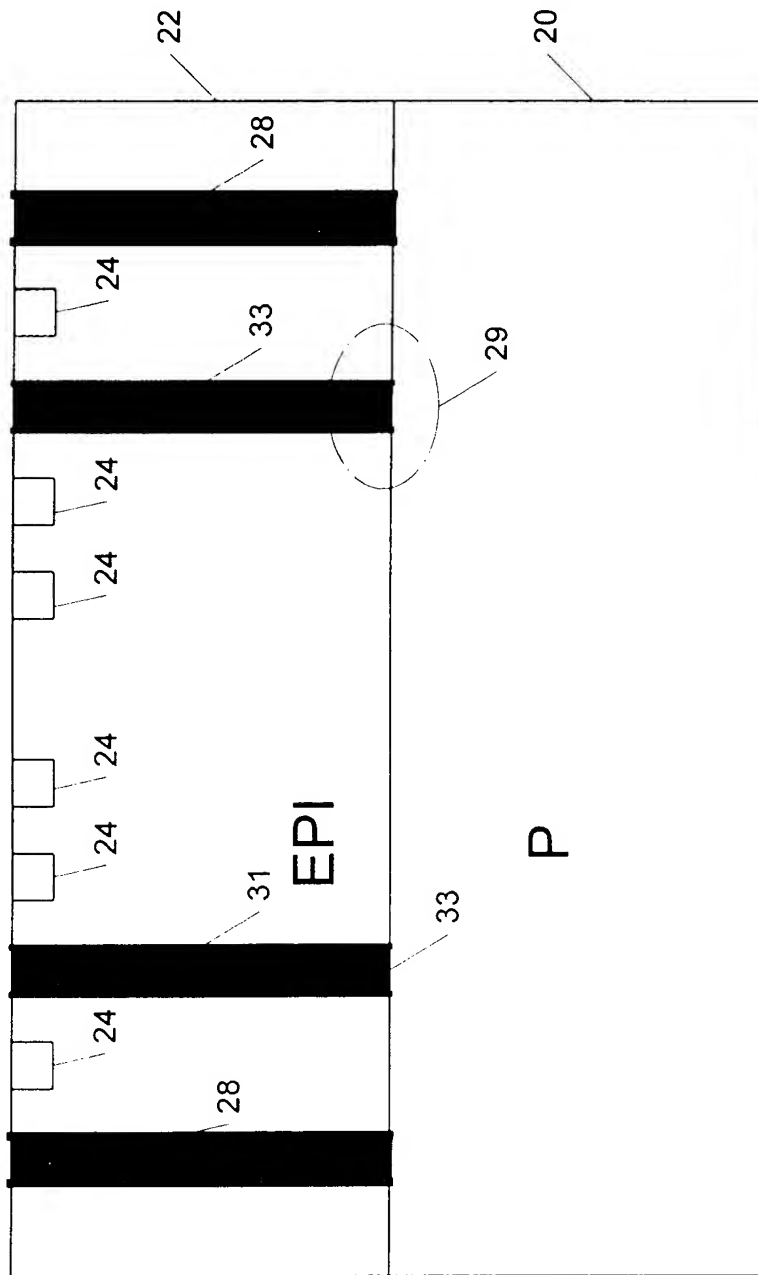


Fig. 2g

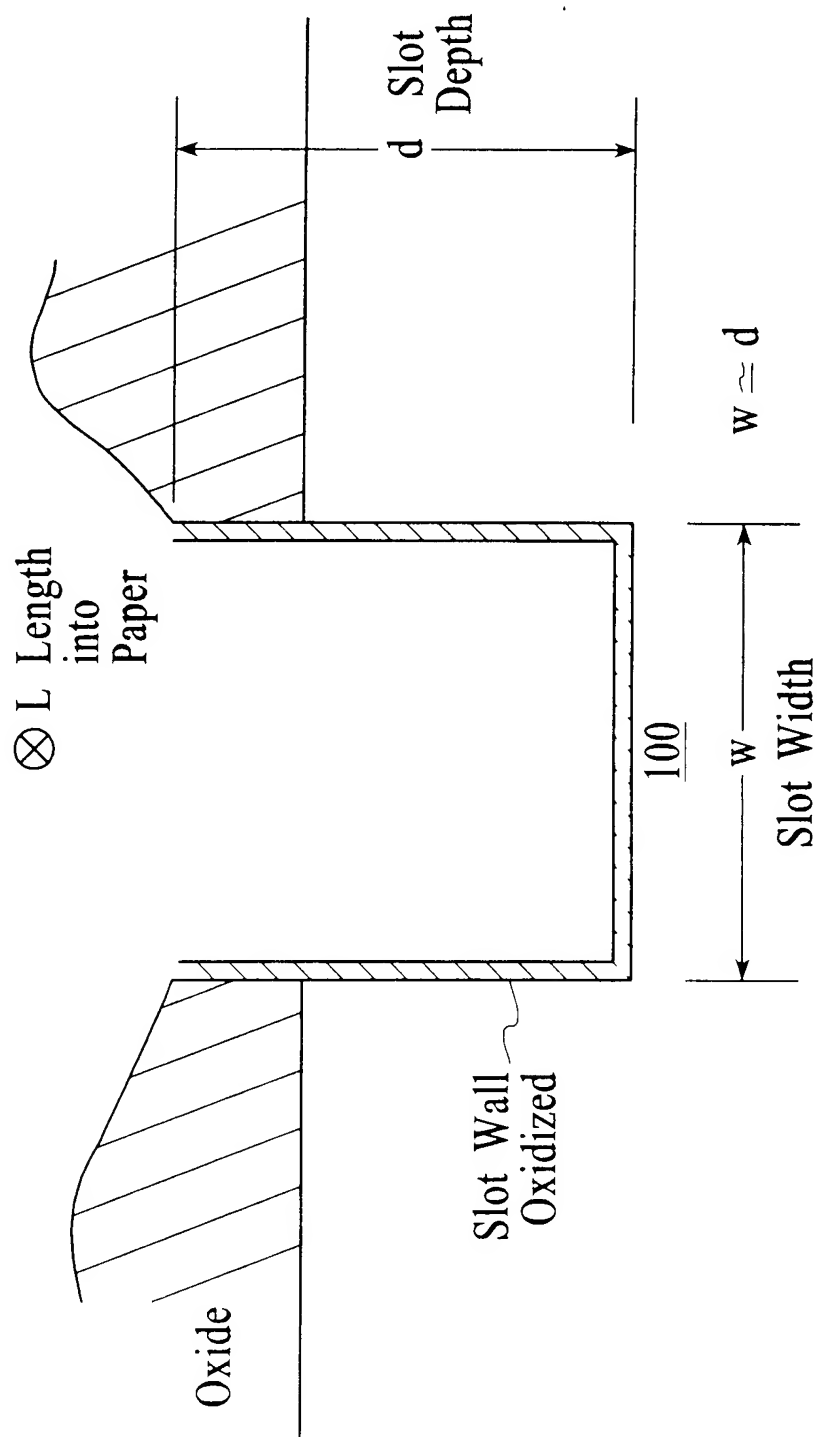


FIG. 3

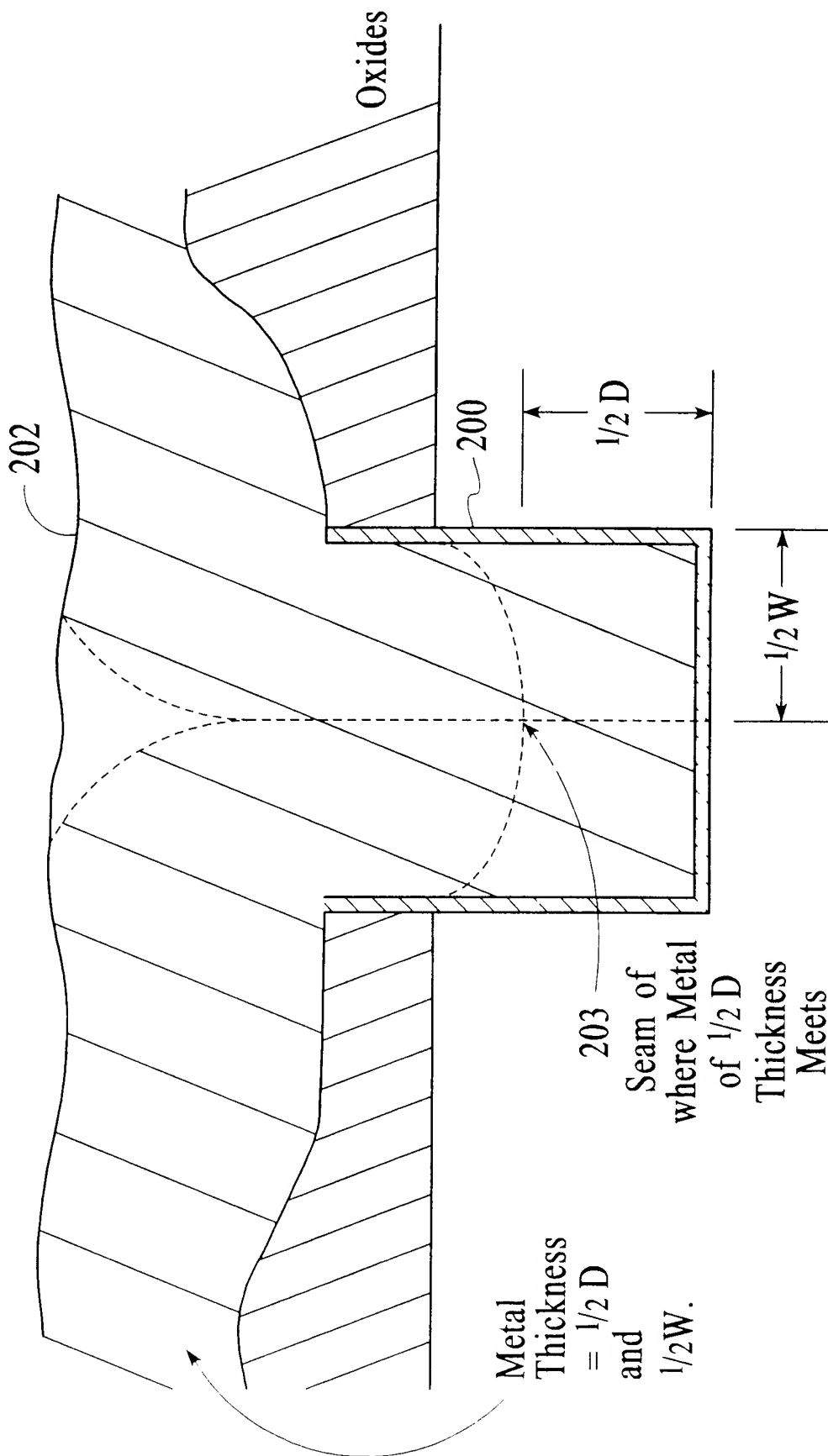


FIG. 4

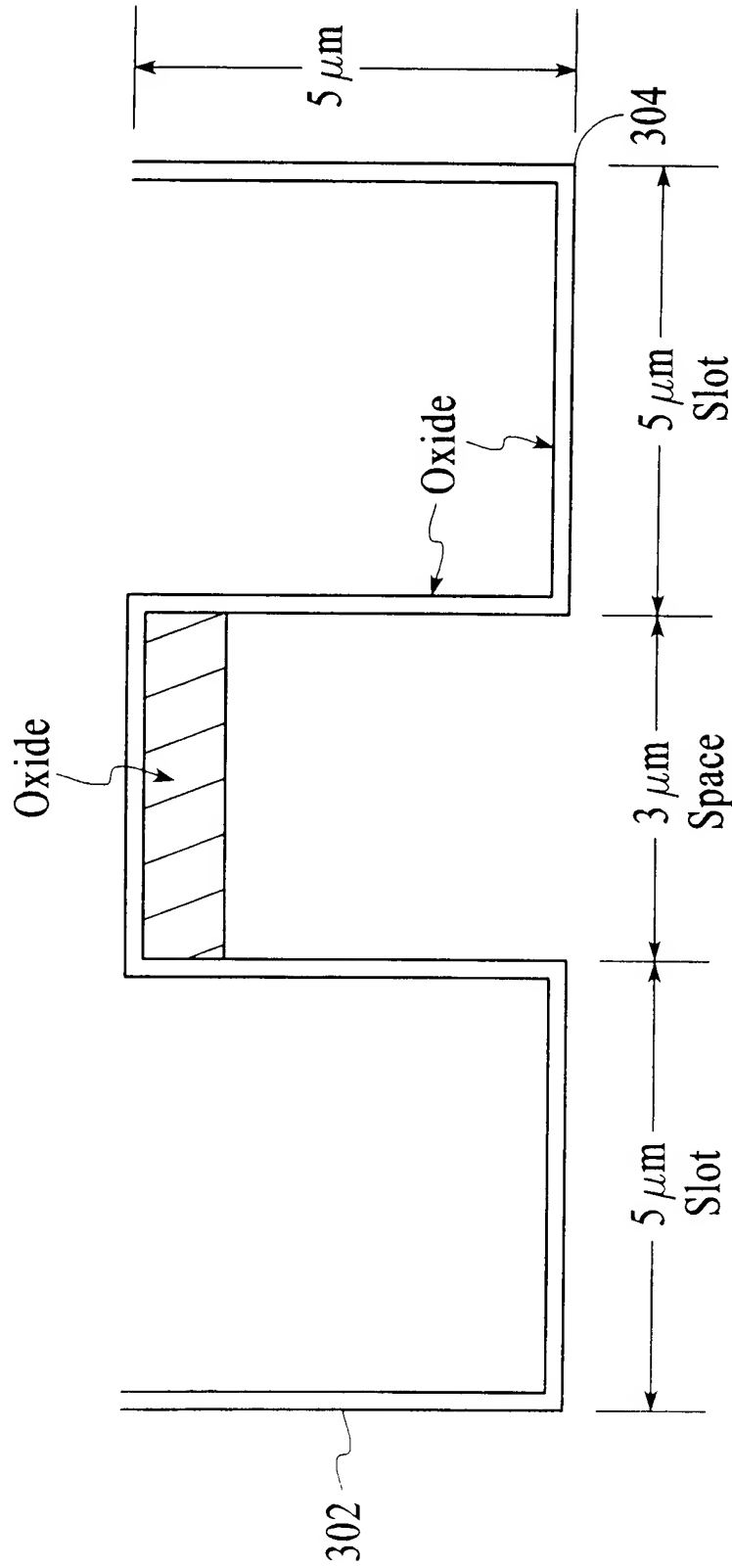


FIG. 4A

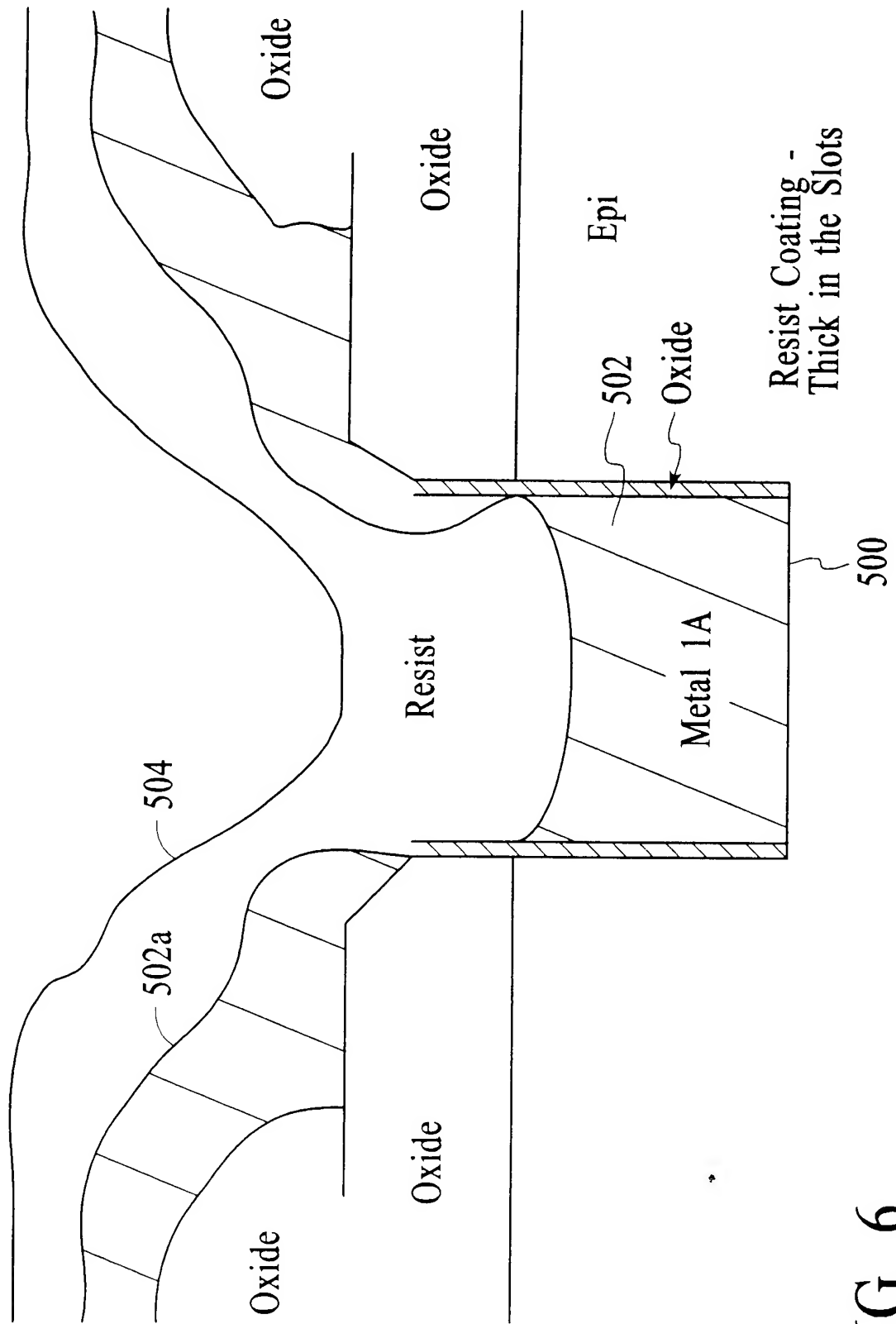
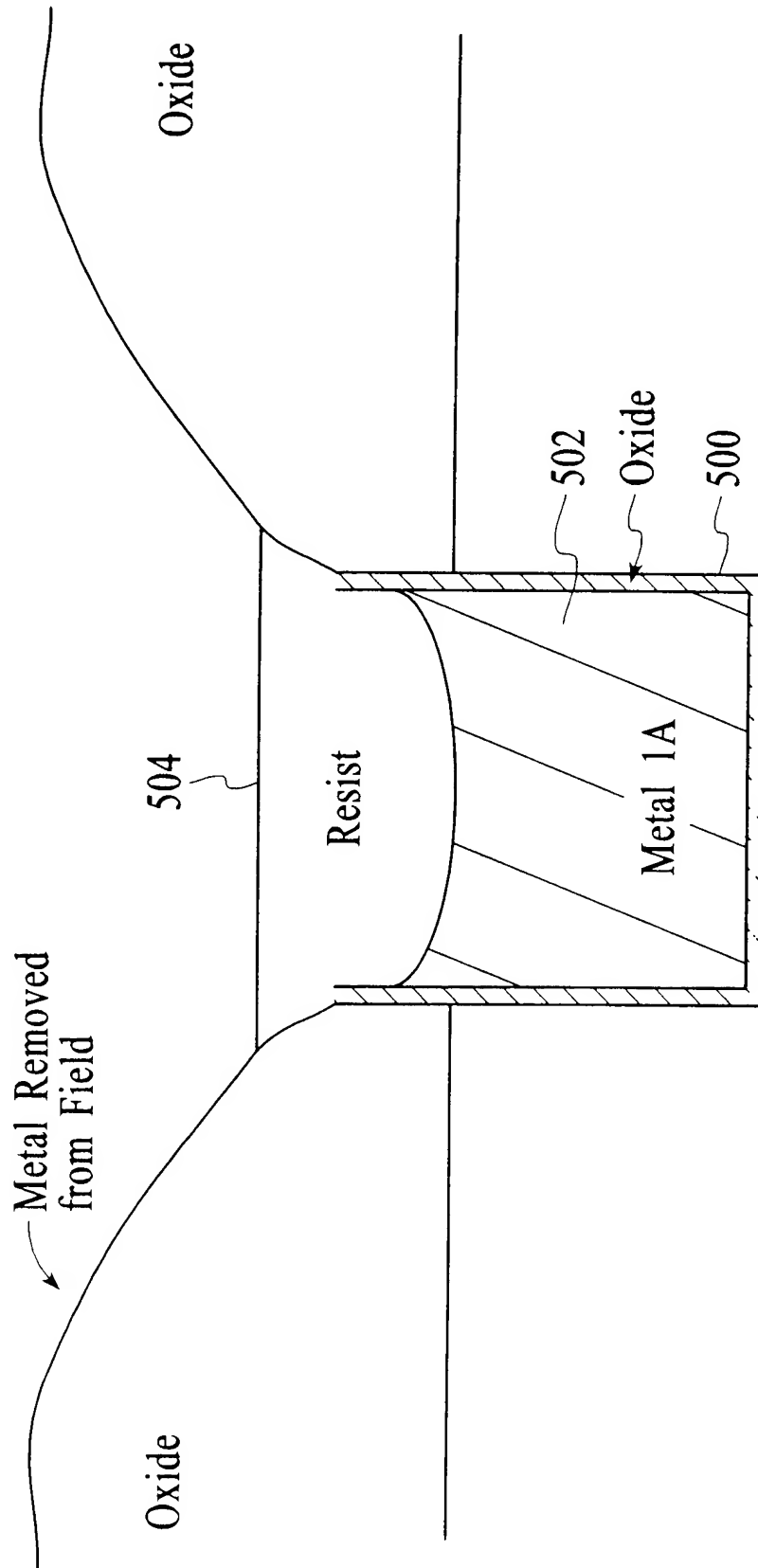
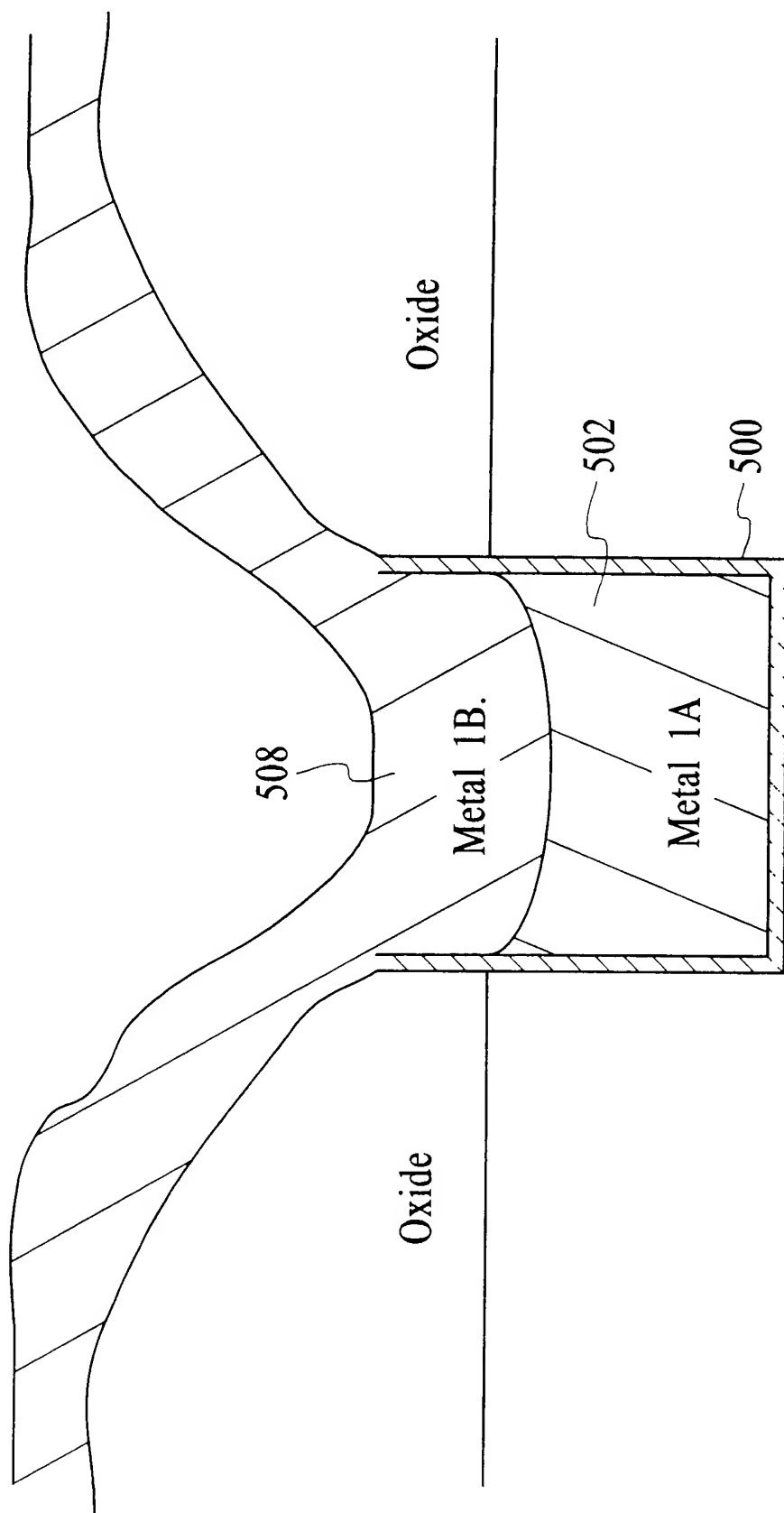


FIG. 6



Resist Planar Etched Leaving Resist
in Slots. Field Metal Etched Off.

FIG. 7



Resist Stripped & Second Metal 1B
Sputter Deposited

FIG. 8

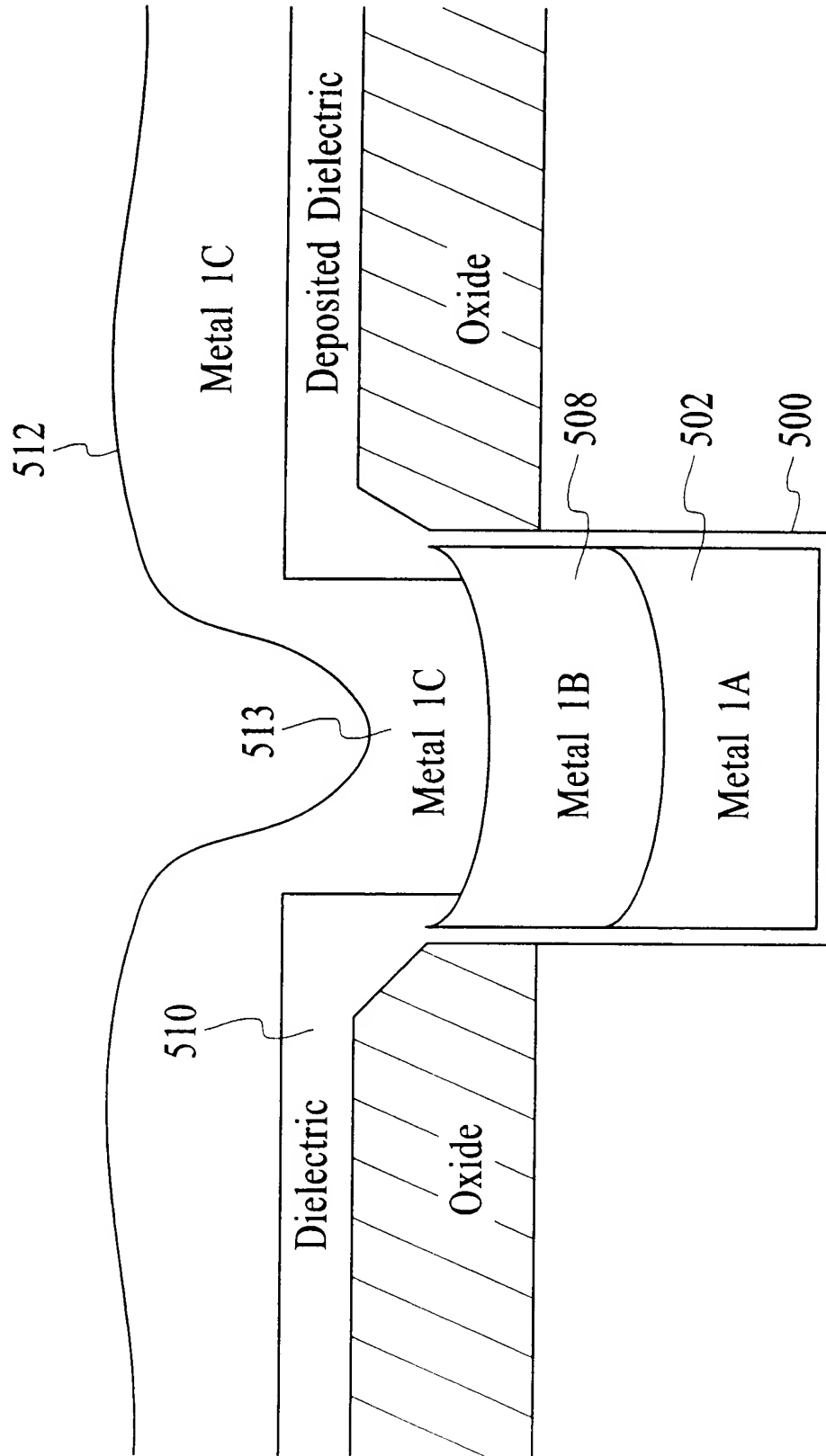


FIG. 9

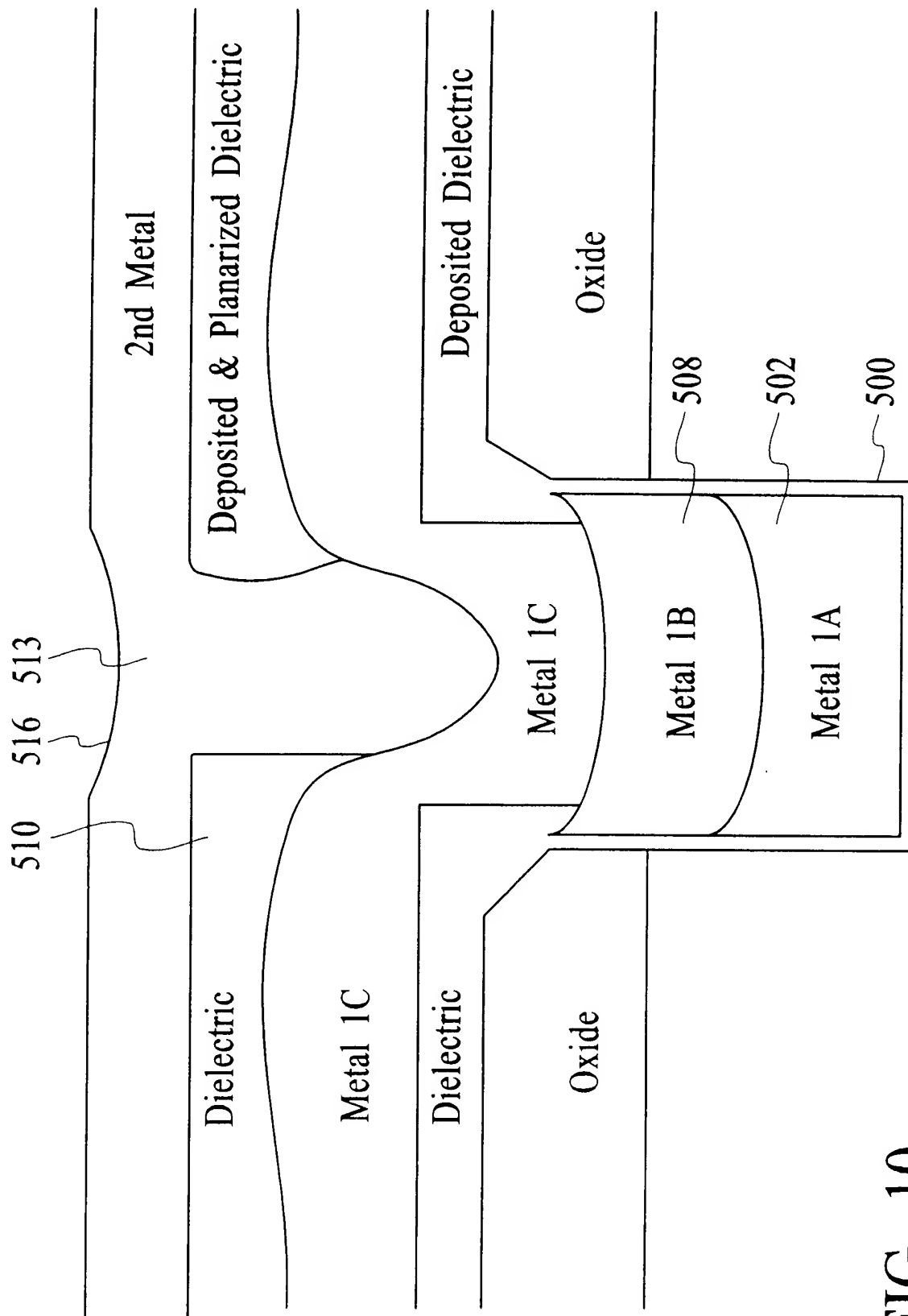


FIG. 10



Shown after layers of Dielectric
followed by 90 OD Å TEOS -
Polish - Slot Mask - Metal.
Metal 1.5 - 2.0 μm deposited.

FIG. 11

Power Metal

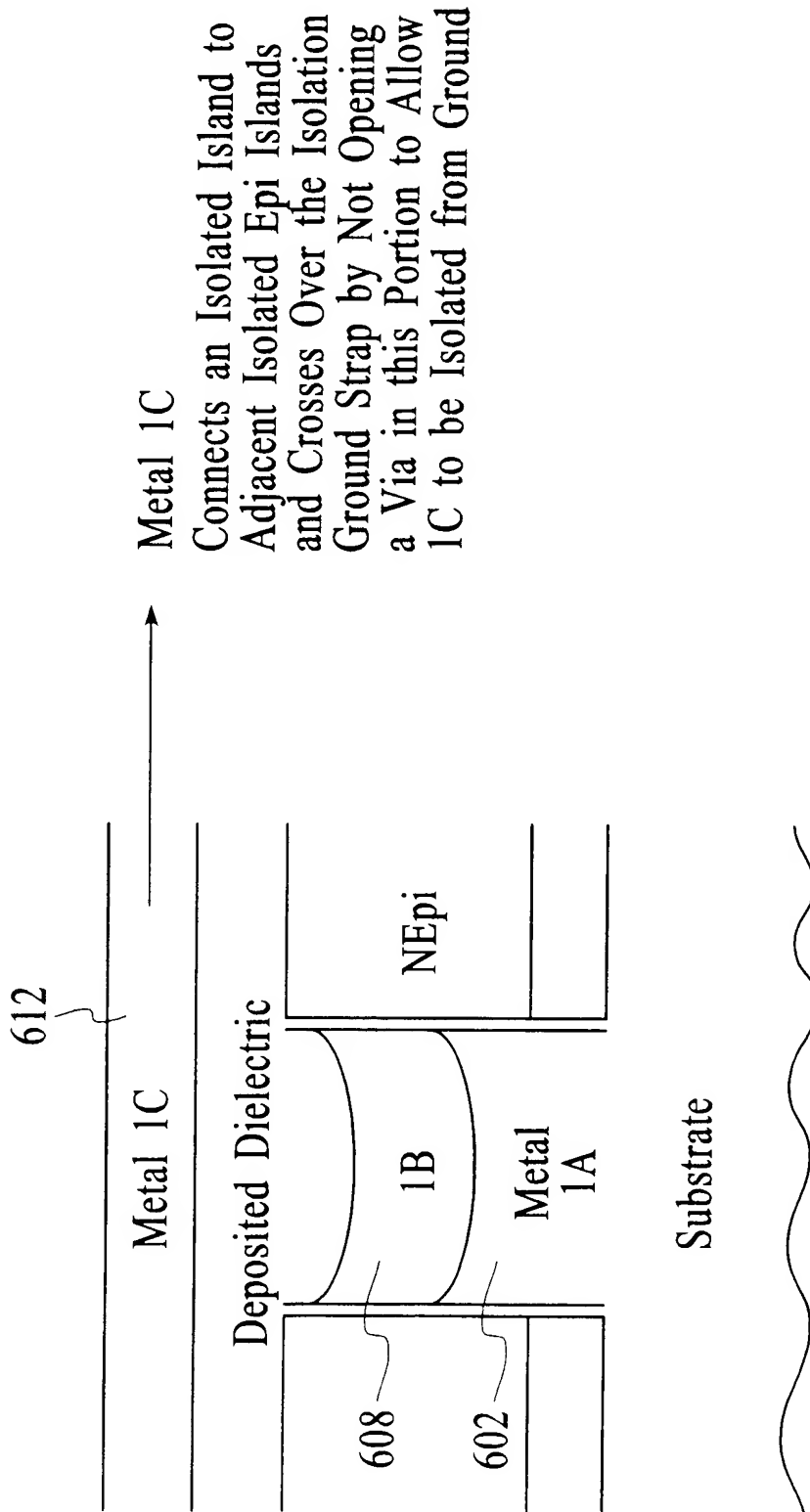


FIG. 12